PCN Number:	20150414000 PCN Date: 04/16/20				04/16/2014									
Title: Datasheet update for LP8728-Q1														
Customer Contact:	PCN Manager			D	ept: Quality Services			ity Services						
Change Type:														
Assembly Site			Design]	Wafer								
Assembly Process		\square	Data Sheet				Bump Material							
Assembly Materials		Ц	Part number change					Process						
Mechanical Specification		Ц	Test Site		╡		Fab Site							
Packing/Shipping/Labeling			Test Process	ļĻ	╡┤			laterials						
PCN Details						rocess								
Description of Change:														
Texas Instruments Incorporated is announcing an information only notification etc. The product datasheet(s) is being updated as summarized below.														
	The product datasticet(s) is being updated as summarized below.													
The following change h	The following change history provides further details.													
_						L	ia Tev	AS						
TEXAS INSTRUMENTS														
LP8728-Q1														
SNVS972B – AUGUST 2013 – REVISED DECEMBER 2014 www.ti.com														
Changes from Revision A (September 2014) to Revision B Page							Page							
Changed simplified schematic circuit drawing to correct pin placements for SW_B3 and SW_B4														
Added ESD Ratings table to replace Handling Ratings														
Changed typical application circuit drawing to correct pin placements for SW_B3 and SW_B4														
The datasheet number	will be chang	ing												
Device Family			Change From:				Change To:							
LP8728-Q1	8728-Q1 SNVS972A				SNVS972B									
These changes may be reviewed at the datasheet links provided.														
http://www.ti.com/product/lp8728-q1														
Reason for Change:														
To more accurately reflect device characteristics.														
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):														
						No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.								
No anticipated impact.					or	nly. The	ere are	e no changes						
No anticipated impact. to the actual device.	This is a spec	cific		ent	or	nly. The	ere are	e no changes						
No anticipated impact. to the actual device.	This is a spec	cific	ation change announcem	ent	or	nly. The	ere are	e no changes						
No anticipated impact. to the actual device. Changes to product i	This is a spec	cific	ation change announcem	ent	or	nly. The	ere are	e no changes						
No anticipated impact. to the actual device. Changes to product i None.	This is a spec	cific	ation change announcem	ent		·	ere are	e no changes						

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com